

HSF

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

NOTES:

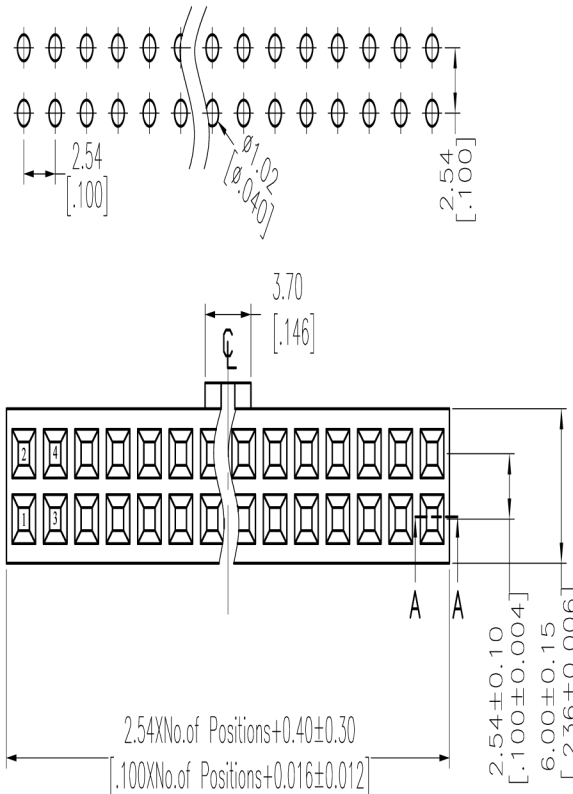
Current Rating: 3.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 1000V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material:Phosphor Bronze or Brass
Contact plating:Au Or Sn over Ni
Insulator Material:PA9T+30%G.F UL94V-0(Std)
Or PBT+30%G.F UL94V-0

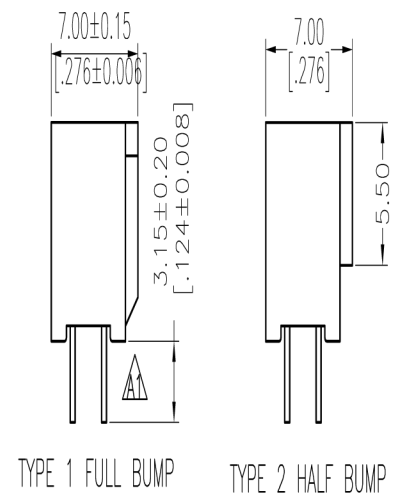
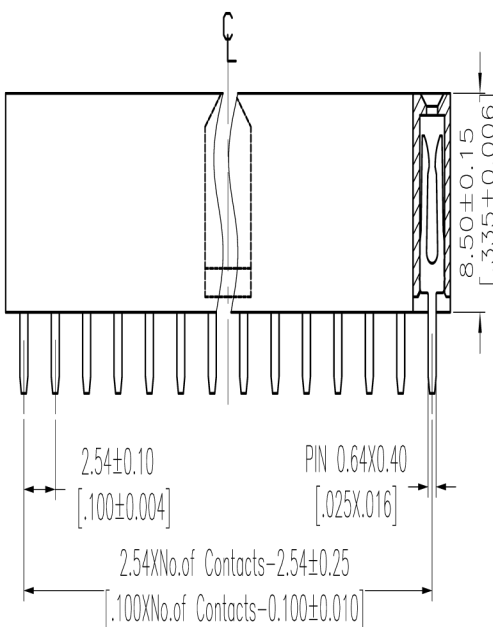
Ordering Information

2185-2XXSXXXYNA X

No. of Pins per ROW:02-27PIN	Contact Plating:	Insulator :	Packing: Series No.
	G0=Gold Flash	A=PBT	T=Tube 3=TYPE 1
	G3=10μ"Gold	C=PA9T	A=Tray 4=TYPE 2
	G4=15μ"Gold		
	G5=30μ"Gold		
	S0=Gold Flash/Tin		
	S3=10μ"Gold/Tin		
	S4=15μ"Gold/Tin		
	S5=30μ"Gold/Tin		
	SN=Tin		
	SM=Matte Tin		



TITLE	PART NO.
TYPE 1	2185-2XXSXXXYNA3
TYPE 2	2185-2XXSXXXYNA4



Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		

			OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2015/08/27	Modify	X.X ±0.40	Allen	2015/08/27	UNIT	mm	SEE TABLE
A1	2014/04/14	Modify drawing	X.XX ±0.25	CHECK	DATE	SIZE	A4	TITLE: FH2.54mm DUAL ROW 180°DIP H=8.50 WITH BUMP
A0	2012/08/15	NEW	X.XXX ±0.15			SHEET	1/1	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DATE	PROJ.		Customer NO.
			DIM TOL					

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